



THE DATASHEET OF ISO6520REUR



Automotive MOSFET

OptiMOS™ 7 Power-Transistor

**Features**

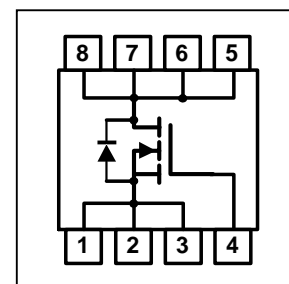
- OptiMOS™ power MOSFET for automotive applications
- N-channel – Enhancement mode – Logic Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

Potential applications

General automotive applications.

Product validation

Qualified for automotive applications. Product validation according to AEC-Q101.

**Product Summary**

V_{DS}	40	V
$R_{DS(on)}$	1.13	mΩ
I_D (chip limited)	222	A

Type	Package	Marking
IAUCN04S7L011	PG-TDSON-8-34	7N04L011



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Maximum ratings

at $T_j=25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	$V_{GS}=10\text{ V}$, Chip limitation ^{1,2)}	222	A
		$V_{GS}=10\text{ V}$, DC current	120	
	$T_a=100\text{ °C}$, $V_{GS}=10\text{ V}$, R_{thJA} on 2s2p ^{2,3)}	36		
Pulsed drain current ²⁾	$I_{D,pulse}$	$T_c=25\text{ °C}$, $t_p=100\text{ }\mu\text{s}$	650	
Avalanche energy, single pulse ²⁾	E_{AS}	$I_D=54\text{ A}$	98	mJ
Avalanche current, single pulse	I_{AS}	–	108	A
Gate source voltage	V_{GS}	–	± 16	V
		limited to duty factor of 1%	+20	V
Power dissipation	P_{tot}	$T_c=25\text{ °C}$	105	W
Operating and storage temperature	T_j, T_{stg}	–	-55 ... +175	°C

Thermal characteristics²⁾

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction - case	R_{thJC}	–	–	0.7	1.4	K/W
Thermal resistance, junction - ambient ³⁾	R_{thJA}	–	–	27	–	

Electrical characteristics

at $T_j=25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{ V}$, $I_D=1\text{ mA}$	40	–	–	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=45\text{ }\mu\text{A}$	1.2	1.5	1.8	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=40\text{ V}$, $V_{GS}=0\text{ V}$, $T_j=25\text{ °C}$	–	–	1	μA
		$V_{DS}=40\text{ V}$, $V_{GS}=0\text{ V}$, $T_j=100\text{ °C}^{2)}$	–	–	11	
Gate-source leakage current	I_{GSS}	$V_{GS}=16\text{ V}$, $V_{DS}=0\text{ V}$	–	–	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=4.5\text{ V}$, $I_D=60\text{ A}$	–	1.39	1.63	m Ω
		$V_{GS}=10\text{ V}$, $I_D=60\text{ A}$	–	0.99	1.13	
Gate resistance ²⁾	R_G	–	–	2.1	–	Ω

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics²⁾						
Input capacitance	C_{iss}	$V_{GS}=0\text{ V}, V_{DS}=20\text{ V}, f=1\text{ MHz}$	-	3261	4240	pF
Output capacitance	C_{oss}		-	1636	2130	
Reverse transfer capacitance	C_{rss}		-	57	85	
Turn-on delay time	$t_{d(on)}$	$V_{DD}=20\text{ V}, V_{GS}=10\text{ V}, I_D=60\text{ A}, R_G=3.5\ \Omega$	-	4	-	ns
Rise time	t_r		-	3	-	
Turn-off delay time	$t_{d(off)}$		-	30	-	
Fall time	t_f		-	15	-	

Gate Charge Characteristics²⁾

Gate to source charge	Q_{gs}	$V_{DD}=20\text{ V}, I_D=60\text{ A}, V_{GS}=0\text{ to }10\text{ V}$	-	9	11	nC
Gate to drain charge	Q_{gd}		-	8	13	
Gate charge total	Q_g		-	49	64	
Gate plateau voltage	$V_{plateau}$		-	2.8	-	V

Reverse Diode

Diode continuous forward current ²⁾	I_S	$T_C=25\text{ °C}$	-	-	120	A
Diode pulse current ²⁾	$I_{S,pulse}$	$T_C=25\text{ °C}, t_p=100\ \mu\text{s}$	-	-	650	
Diode forward voltage	V_{SD}	$V_{GS}=0\text{ V}, I_F=60\text{ A}, T_j=25\text{ °C}$	-	0.8	0.95	V
Reverse recovery time ²⁾	t_{rr}	$V_R=20\text{ V}, I_F=50\text{ A}, di_f/dt=100\text{ A}/\mu\text{s}$	-	34	51	ns
Reverse recovery charge ²⁾	Q_{rr}		-	21	41	

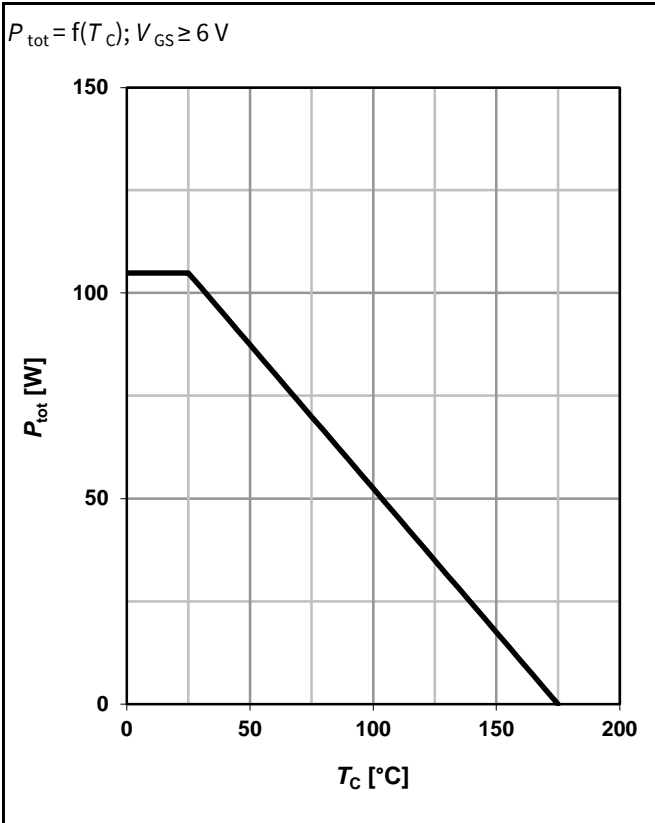
¹⁾ Practically the current is limited by the overall system design including the customer-specific PCB.

²⁾ The parameter is not subject to production testing – specified by design.

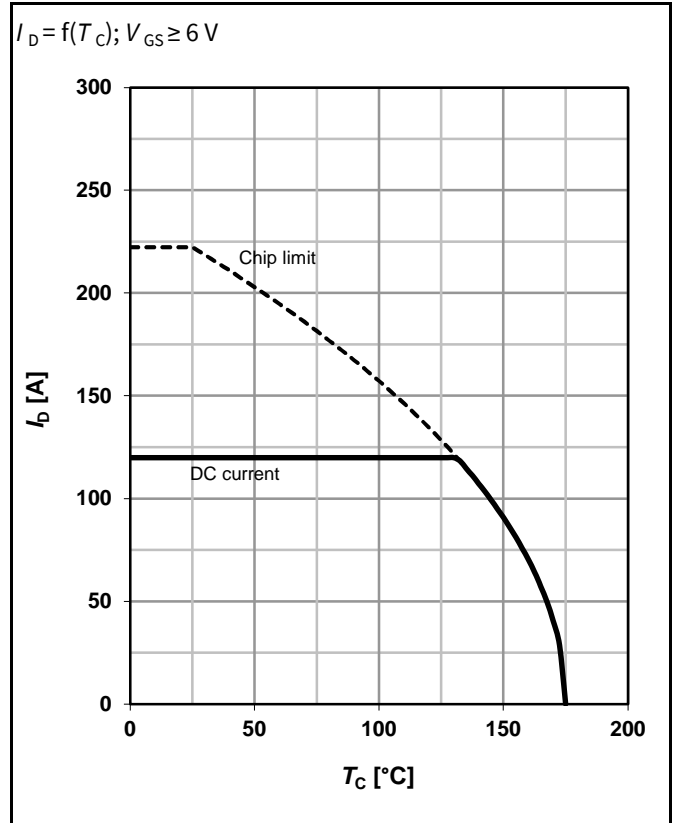
³⁾ Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

Electrical characteristics diagrams

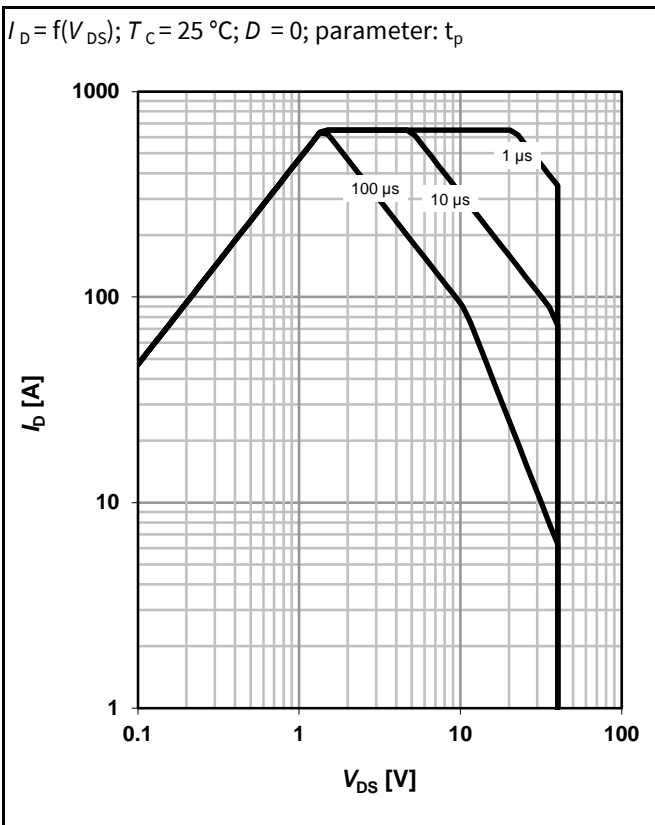
1 Power dissipation



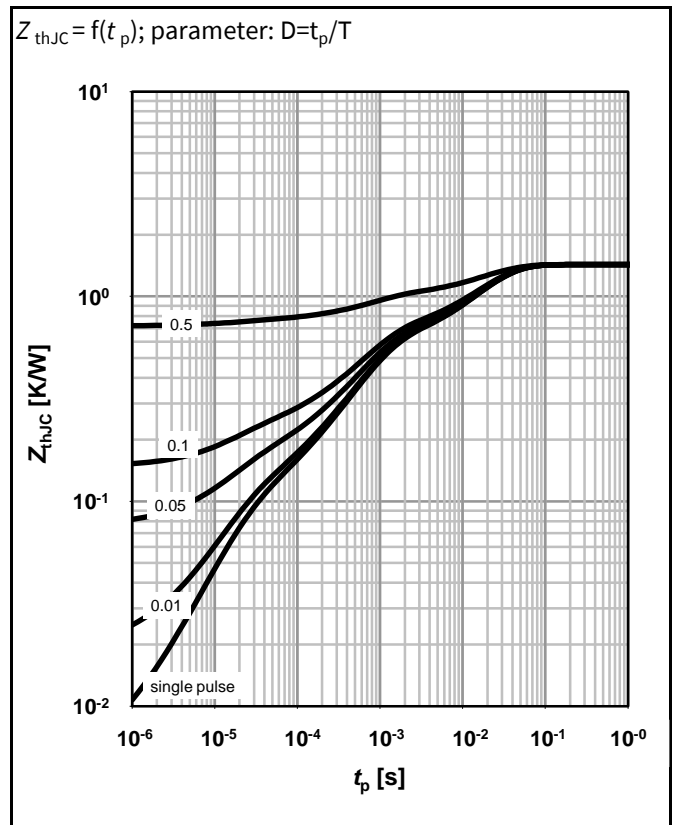
2 Drain current



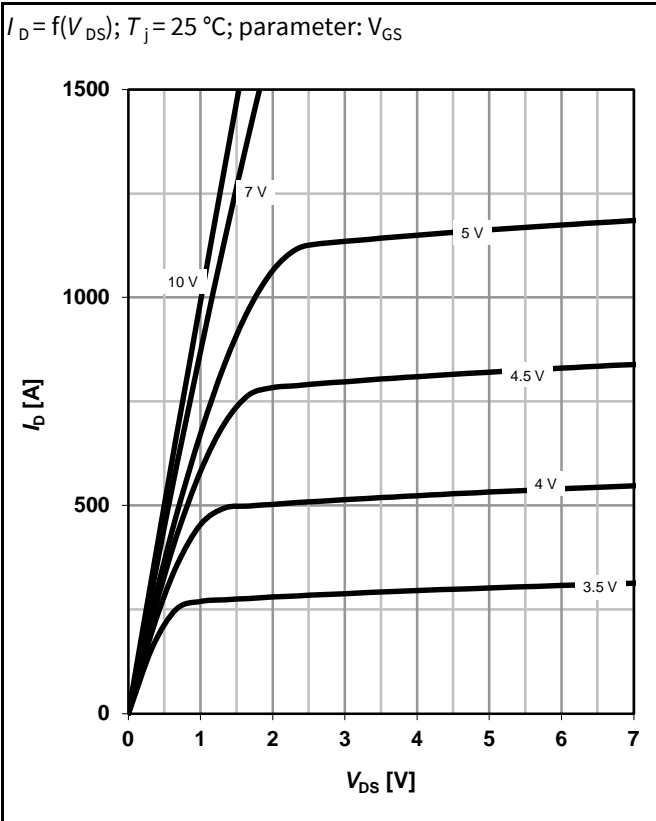
3 Safe operating area



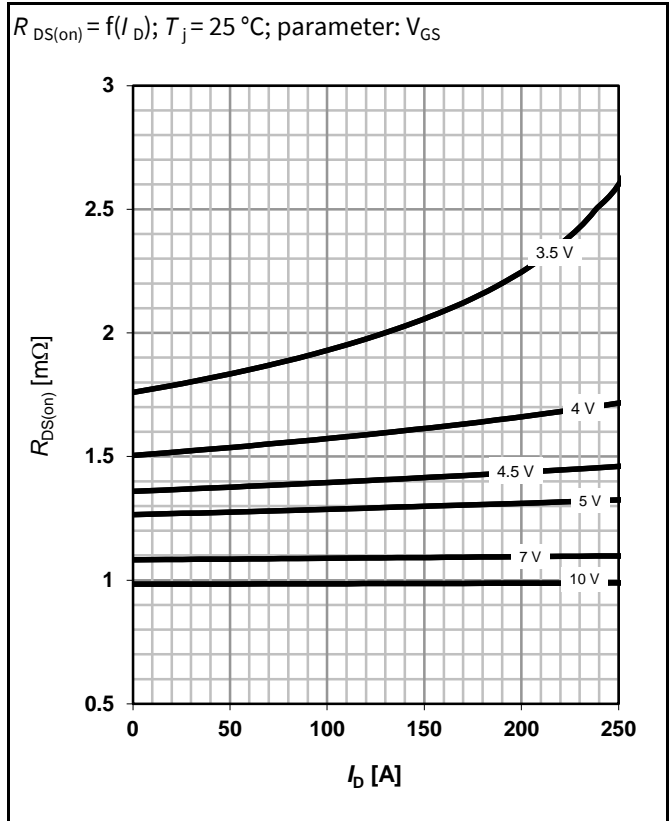
4 Max. transient thermal impedance



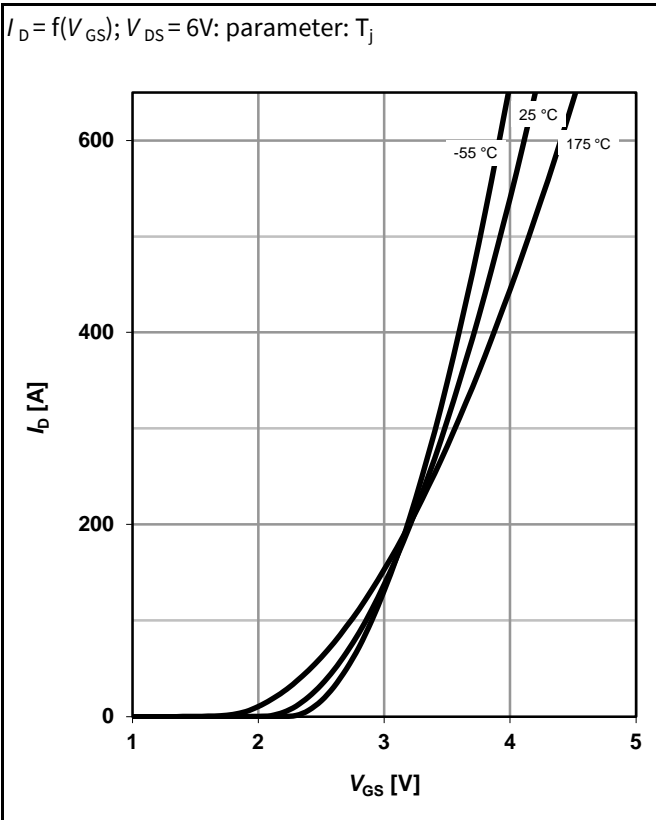
5 Typ. output characteristics



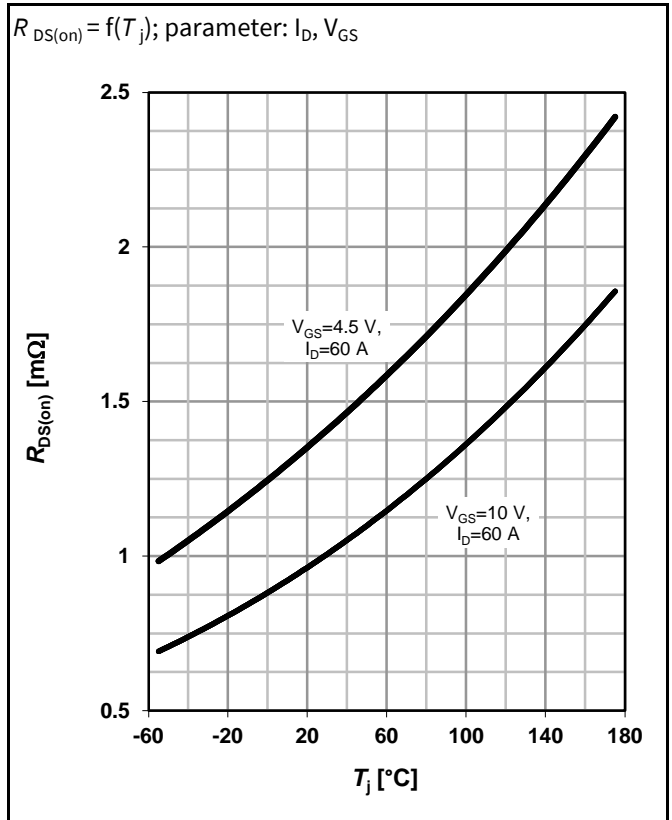
6 Typ. drain-source on-state resistance



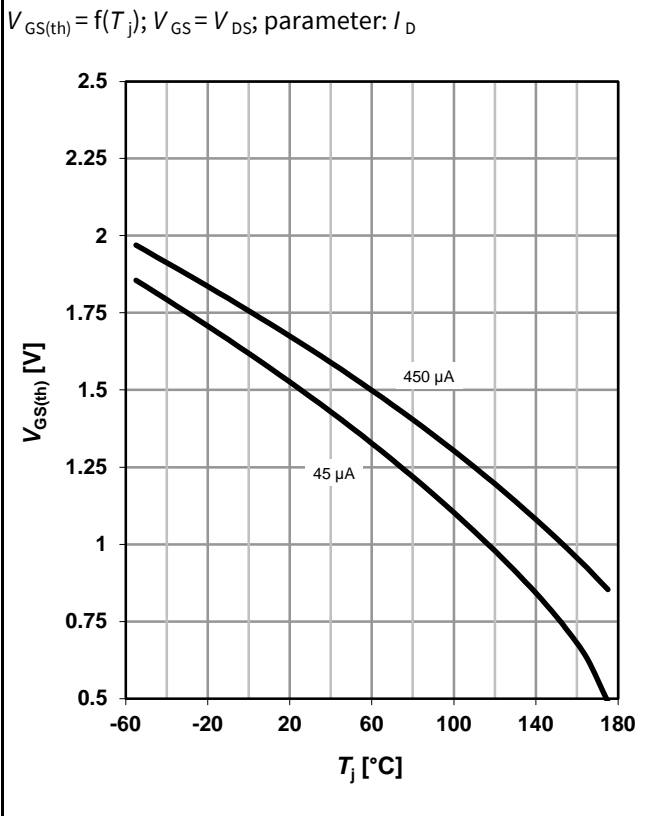
7 Typ. transfer characteristics



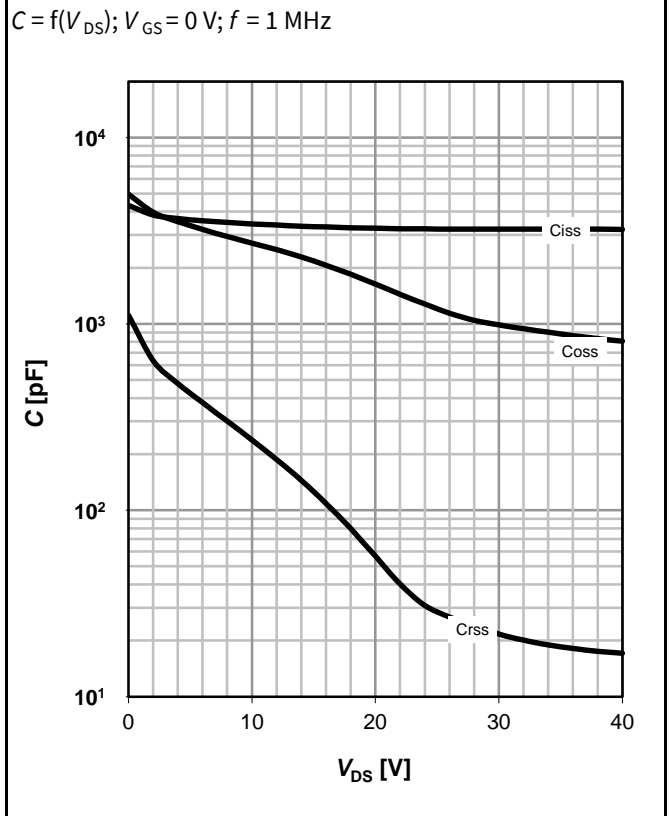
8 Typ. drain-source on-state resistance



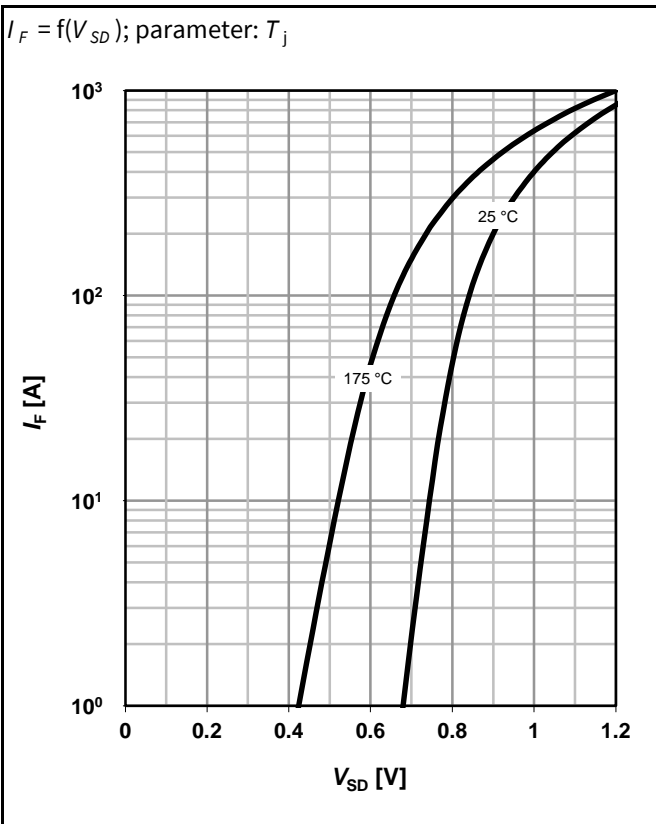
9 Typ. gate threshold voltage



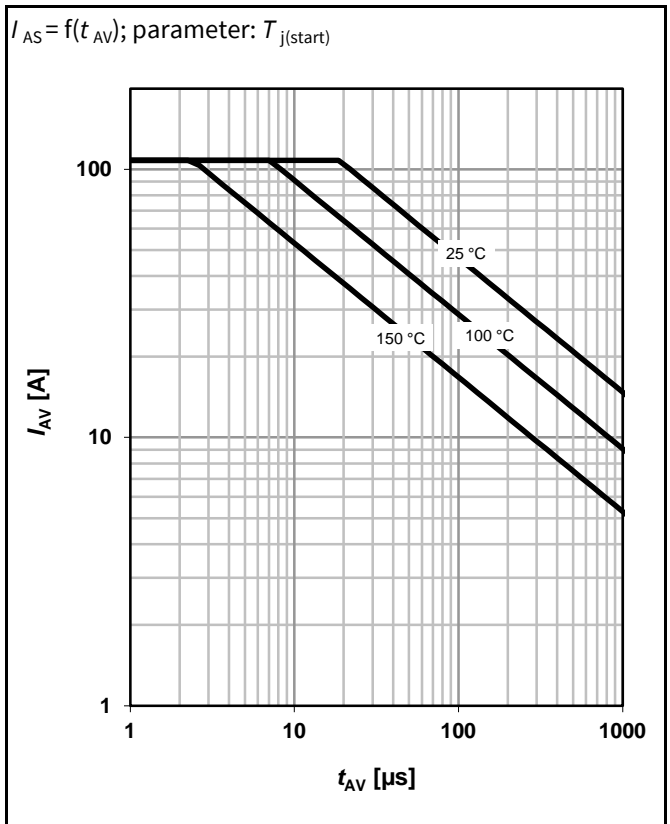
10 Typ. capacitances



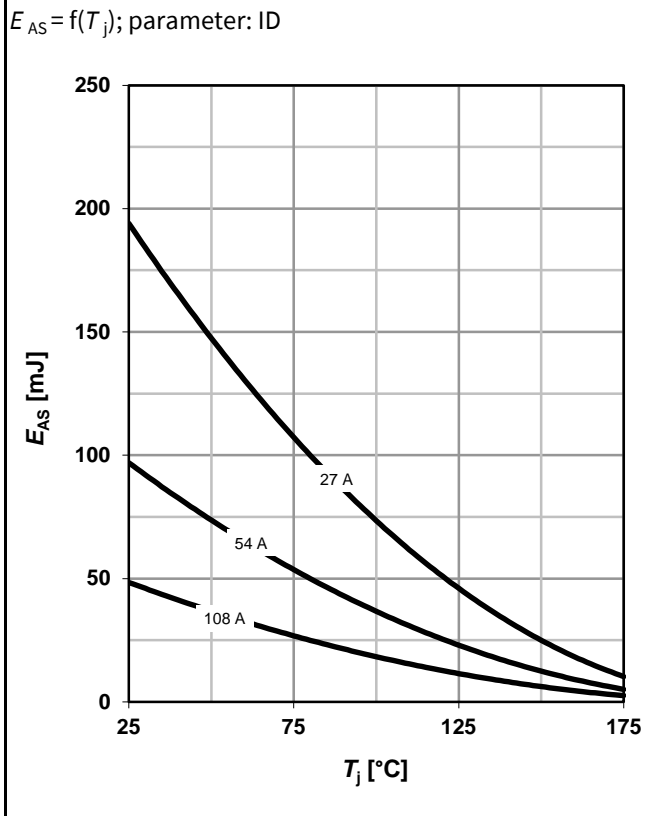
11 Typical forward diode characteristics



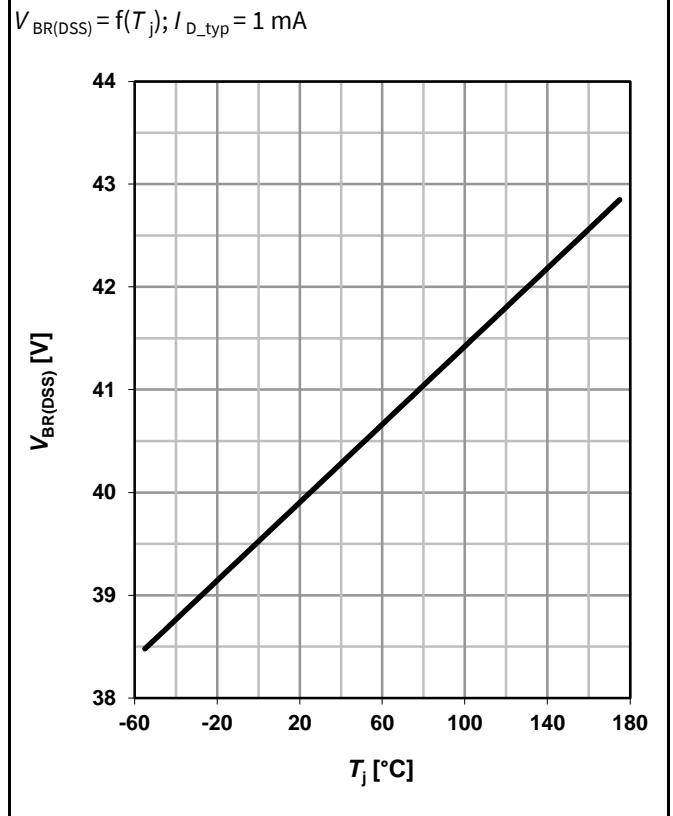
12 Typ. avalanche characteristics



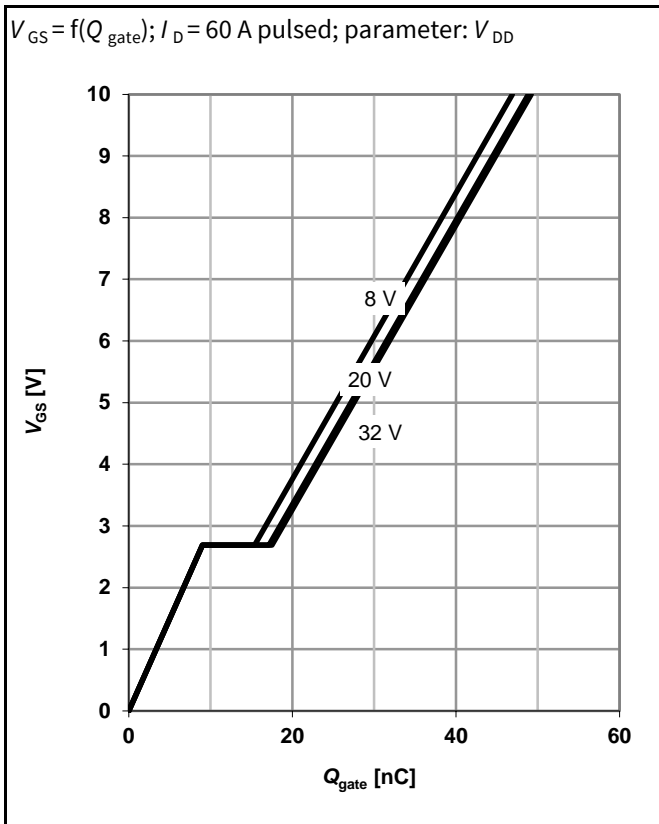
13 Typical avalanche energy



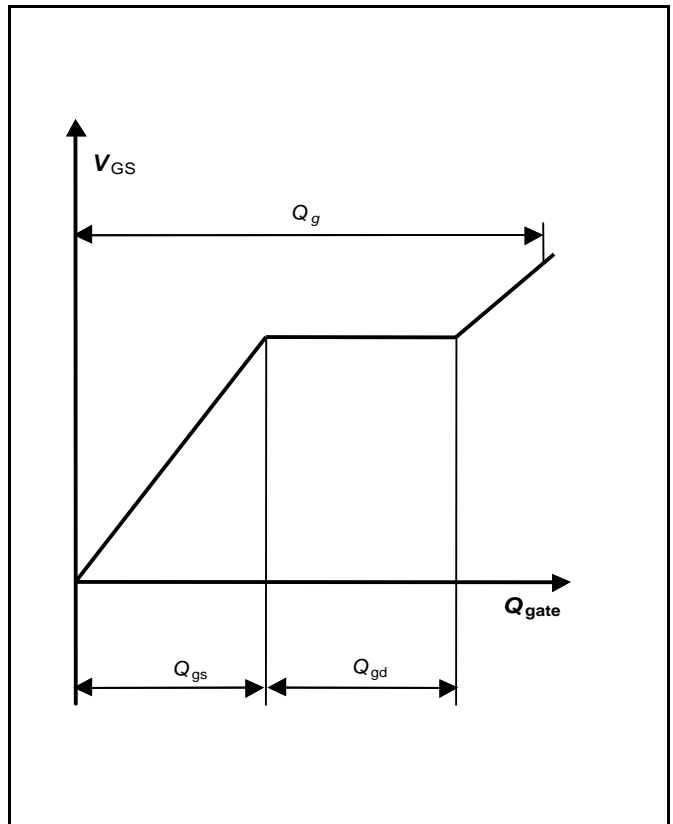
14 Drain-source breakdown voltage



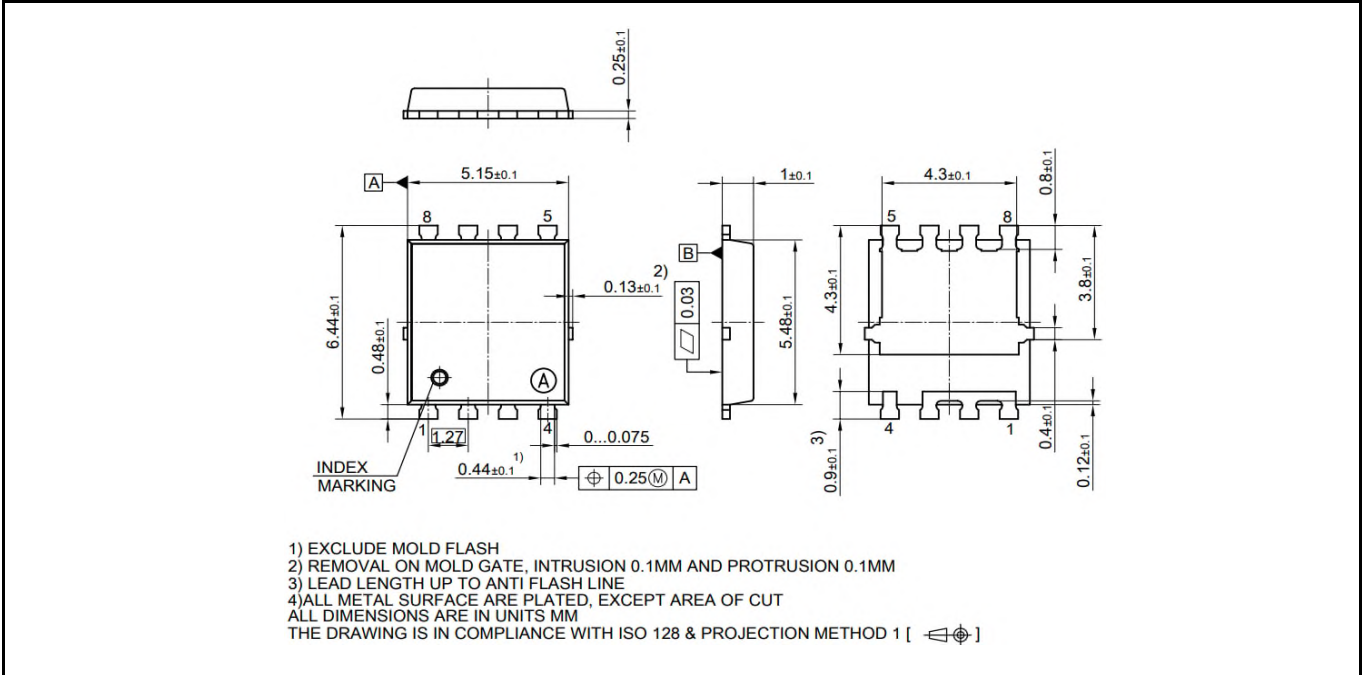
15 Typ. gate charge



16 Gate charge waveforms

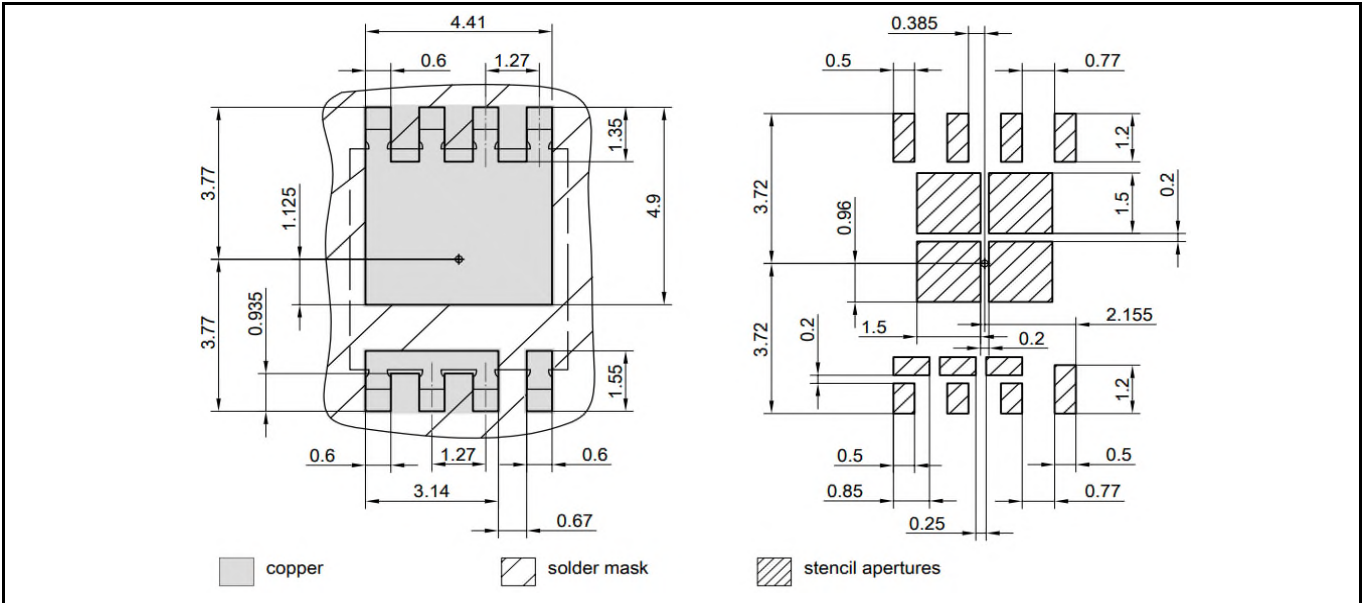


Package Outline



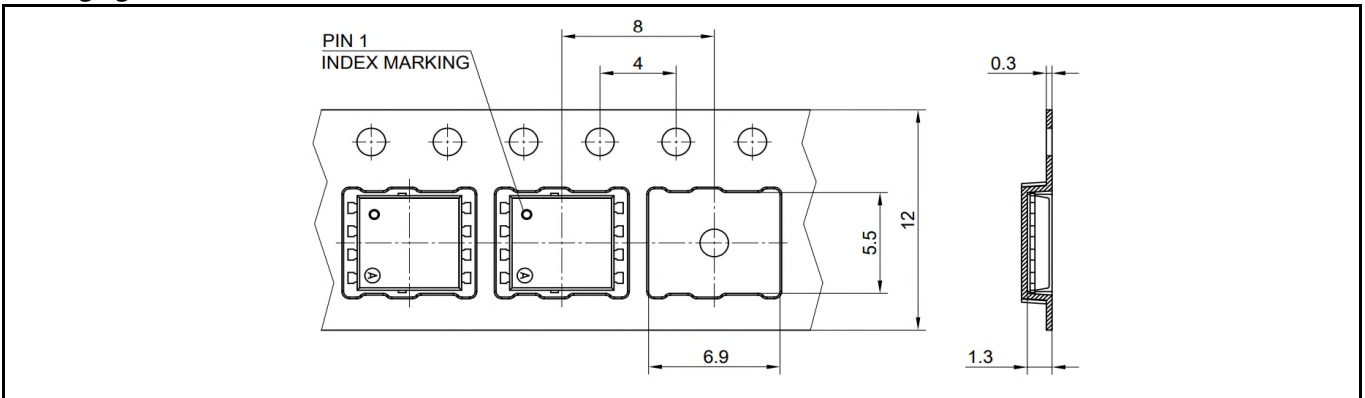
All dimensions are in units mm

Footprint



All dimensions are in units mm

Packaging



All dimensions are in units mm



Revision History

Revision	Date	Changes
Revision 1.0	15.11.2023	Final Data Sheet

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